

08-13-2003

JULY 28, 1992

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NOTE: The following appendix did not appear in the Code of Federal Regulations

**APPENDIX B**

FORM PTO-1595

1-31-92

**RECORDATION FORM COVER SHEET  
PATENTS ONLY**

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

To the Commissioner of Patents: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Quang Le  
Jui-lung Li  
Jeffrey S. Lille  
Son Van Nguyen

2. Name and address of receiving party(ies):

Name: Hitachi Global Storage Technologies  
Netherlands B. V.

Street Address:

Locatellikade 1  
1076 AZ Amsterdam  
P. O. Box 75215  
1070 AE Amsterdam  
The Netherlands

Additional name(s) &amp; address(es) attached?

yes ☒ noAdditional name(s) of conveying party(ies) attached? yes ☐ no ☒

3.

Nature of Conveyance

☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other

Execution Date: 7/17/2003, 7/18/2003, 7/22/2003, 7/24/2003

4.

Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes ☐ No ☒

5. Name and address of party to whom correspondence concerning documents should be mailed:

Name: Hitachi Global Storage Technologies

Internal

Address: Intellectual Property Law

Street

Address: 5600 Cottle Road, Dept. NHGB/014-2  
San Jose, California 951936. Total number of applications and patents involved: one7. Total Fee (37 CFR 3.41): \$ 40.00☐ Enclosed  
☒ Authorized to be charged to  
deposit account8. Deposit Account Number: 50-2587

08/12/2003 ECOOPER 00000071 502587 10631706

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

July 30, 2003

Date

Ron Feece

Printed name of person signing

Signature

Total Number of pages including cover sheet, attachments and document: 2

OMB NO. 0651-0011 (EXP. 4/94)

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MS: Assignment Recordation Services  
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**PATENT  
REEL: 014365 FRAME: 0873**22212 U.S. PTO  
10/631706  
07/30/03

ASSIGNMENT

Whereas, we

INVENTOR  
AND CITY

- |   |   |
|---|---|
| (1) <b>Quang Le</b><br>City of <b>San Jose</b> ,<br>County of <b>Santa Clara</b> ,<br>State of <b>California</b> ,    | (3) <b>Jeffrey S. Lille</b><br>City of <b>Sunnyvale</b> ,<br>County of <b>Santa Clara</b> ,<br>State of <b>California</b> , |
| (2) <b>Jui-lung Li</b><br>City of <b>San Jose</b> ,<br>County of <b>Santa Clara</b> ,<br>State of <b>California</b> , | (4) <b>Son Van Nguyen</b><br>City of <b>San Jose</b> ,<br>County of <b>Santa Clara</b> ,<br>State of <b>California</b> ,    |

have invented certain improvements in

TITLE

**METHOD OF MAKING A PERPENDICULAR RECORDING MAGNETIC HEAD POLE TIP WITH AN ETCHABLE ADHESION CMP STOP LAYER**

DATE THAT  
INVENTOR  
SIGNED THE  
DECLARATION

and executed a Declaration and Power of Attorney for a United States patent application therefor on

- (1) 7/17, 2003  
(2) July 22, 2003  
(3) July 18, 2003  
(4) \_\_\_\_\_, 2003

Whereas, HITACHI GLOBAL STORAGE TECHNOLOGIES NETHERLANDS, B.V., having a place of business at Locatellikade 1, 1076 AZ Amsterdam, The Netherlands (hereinafter called HITACHI), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to HITACHI, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to HITACHI, its successors and assigns; and we hereby agree that HITACHI may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by HITACHI.

Signed

CITY  
DATE

(1) at 7/17/03  
on Quang Le, 2003,

SIGNATURE  
INVENTOR

CITY  
DATE

(2) at San Jose  
on July 22, 2003,

SIGNATURE  
INVENTOR

CITY  
DATE

(3) at SAN JOSE, CAL  
on July 18, 2003,

SIGNATURE  
INVENTOR

CITY  
DATE

(4) at \_\_\_\_\_  
on \_\_\_\_\_, 2003,

SIGNATURE  
INVENTOR

ASSIGNMENT

Whereas, we

INVENTOR  
AND CITY

(1) **Quang Le**  
City of **San Jose**,  
County of **Santa Clara**,  
State of **California**,

(3) **Jeffrey S. Lille**  
City of **Sunnyvale**,  
County of **Santa Clara**,  
State of **California**,

(2) **Jui-lung Li**  
City of **San Jose**,  
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Signed

CITY  
DATE

(1) at  
on \_\_\_\_\_, 2003,

\_\_\_\_\_  
**Quang Le** SIGNATURE  
INVENTOR

CITY  
DATE

(2) at  
on \_\_\_\_\_, 2003,

\_\_\_\_\_  
**Jui-lung Li** SIGNATURE  
INVENTOR

CITY  
DATE

(3) at  
on \_\_\_\_\_, 2003,

\_\_\_\_\_  
**Jeffrey S. Lille** SIGNATURE  
INVENTOR

CITY  
DATE

(4) at  
on July 24, 2003,

Son Van Nguyen  
**Son Van Nguyen** SIGNATURE  
INVENTOR